Ruggedized 6Gbps SATA Redriver with High ESD and Extended Temperature Operation

General Description

The MAX14970 dual-channel buffer with input equalization and preemphasis is ideal to redrive internal serial-ATA (SATA) 1i, 2i, and 3i signals as well as eSATA 1m and 2m signals. The device features high electrostatic discharge (ESD), $\pm 8kV$ Human Body Model (HBM) protection. The device can be placed near a SATA connector on the motherboard to overcome board losses and guarantee SATA compliance. The device is SATA specification version 3.0 (gold standard) compliant and can also be pin configured for SATA specification version 2.6 (gold standard) compliance.

The device features hardware SATA-drive cable detection that automatically places the device into a standby mode that consumes less than 20μ A (typ) standby current when no drive is connected. In addition, the device features an independent channel dynamic power-down mode where power consumption is reduced when no input signal is present. The device maintains output common-mode levels to meet internal SATA version 3.0 standards and prevent delays when coming out of low-power mode.

The device preserves signal integrity at the receiver by reestablishing full output levels and reducing the total system jitter (T_J) by providing equalization. The device features channel-independent digital preemphasis controls to drive SATA outputs over longer trace lengths to meet internal SATA specifications. SATA out-of-band (OOB) signaling is supported using high-speed out-of-band signal detection on the inputs, and squelch on the corresponding outputs. Inputs and outputs are all internally 50Ω terminated and must be AC-coupled to the SATA controller IC and SATA device.

The device operates from a single +3.3V (typ) supply, is available in a small, $4mm \times 4mm$ TQFN package with flowthrough traces for ease of layout, and is specified over the extended $-40^{\circ}C$ to $+85^{\circ}C$ operating temperature range.

Benefits and Features

- Robust Solution for Harsh Environments
 - Extended Temp Rating: -40°C to +85°C
 - High ESD Protection on All Pins: ±8kV (HBM)
 - TQFN (4mm x 4mm) Package for Resistance to Vibration/Shocks
- Unique Power-Saving Design
 - Standby State: <1mW (typ)
 - Dynamic Power-Down State Idle State: 52.8mW (typ) Active State: 231mW (typ)
- Design Flexibility
 - Input Equalization and Selectable Output Preemphasis
 - Single 3.3V Supply Operation
 - SATA 3i (6.0Gbps), SATA 2i/2m (3.0Gbps), and SATA 1i/1m(1.5Gbps) Compatible

Applications

- Industrial/Embedded PC
- Portable IPC/HMI
- Industrial Server
- Medical
- SATA SSDs or HDDs

<u>Ordering Information</u> appears at end of data sheet.

For related parts and recommended products to use with this part, refer to: www.maximintegrated.com/MAX14970.related



Ruggedized 6Gbps SATA Redriver with High ESD and Extended Temperature Operation

Absolute Maximum Ratings

(All voltages referenced to GND, unless otherwise noted.)	
-0.3V to +4	4.0V
AINP, AINM, BINP, BINM, EN, CAD,	
MODE, PA, PB (Note 1)0.3V to (V _{CC} + 0	.3V)
Short-Circuit Output Current	
AOUTP, AOUTM, BOUTP, BOUTM	OmA
Continuous Current at Inputs	
AINP, AINM, BINP, BINM±	5mA

Continuous Power Dissipation (T _A = +70°C)	
TQFN (derate 25.6mW/°C above +70°C)	2051mW
Operating Temperature Range	40°C to +85°C
Storage Temperature Range	-55°C to +150°C
Lead Temperature (soldering, 10s)	+300°C
Soldering Temperature (reflow)	+260°C

Note 1: All I/O pins are clamped by internal diodes.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Thermal Characteristics (Note 2)

TQFN

Note 2: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

Electrical Characteristics

 $(V_{CC} = +3.0V \text{ to } +3.6V, C_{CL} = 10nF \text{ coupling capacitor on each output, } R_L = 50\Omega, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at } V_{CC} = +3.3V, T_A = +25^{\circ}C.)$ (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Power-Supply Range	V _{CC}		3.0		3.6	V
Operating Supply Current		PA = PB = V _{CC} , D10.2 pattern, f = 3GHz, active state		70	100	mA
Operating Supply Current	ICC	PA = PB = GND, D10.2 pattern, f = 3GHz, active state		60	85	
Standby Supply Current	I _{STBY}	EN = GND or \overline{CAD} = V _{CC}		20	500	μA
Dynamic Power-Down Current	IDYNPD			16	20	mA
Differential Input Resistance	Z _{RX-DIFF-DC}	(Note 4)	85	100	115	Ω
Differential Output Resistance	Z _{TX-DIFF-DC}	(Note 4)	85	100	115	Ω
AC PERFORMANCE						
		150MHz ≤ f < 300MHz	18			
		300MHz ≤ f < 600MHz	14			
Differential Input Return Loss (Notes 4, 5)	RL _{RX-DIFF}	600MHz ≤ f < 1200MHz	10			dB
		1.2GHz ≤ f < 2.4GHz	8			
		2.4GHz ≤ f ≤ 3.0GHz	3			1

Ruggedized 6Gbps SATA Redriver with High ESD and Extended Temperature Operation

Electrical Characteristics (continued)

 $(V_{CC} = +3.0V \text{ to } +3.6V, C_{CL} = 10nF \text{ coupling capacitor on each output, } R_L = 50\Omega, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at } V_{CC} = +3.3V, T_A = +25^{\circ}C.)$ (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
		150MHz ≤ f < 300MHz	5				
		300MHz ≤ f < 600MHz	5]	
Common-Mode Input Return Loss (Notes 4, 5)	RL _{RX-CM}	600MHz ≤ f < 1200MHz	2			dB	
2033 (100125 4, 3)		1.2GHz ≤ f < 2.4GHz	2				
		2.4GHz ≤ f ≤ 3.0GHz	2			1	
		150MHz ≤ f < 300MHz	14				
		300MHz ≤ f < 600MHz	8			1	
Differential Output Return Loss (Notes 4, 5)	RL _{TX-DIFF}	600MHz ≤ f < 1200MHz	6			dB	
(110165 4, 5)		1.2GHz ≤ f < 2.4GHz	6				
		2.4GHz ≤ f ≤ 3.0GHz	3				
		150MHz ≤ f < 300MHz	8				
		300MHz ≤ f < 600MHz	5				
Common-Mode Output Return Loss (Notes 4, 5)	RL _{TX-CM}	600MHz ≤ f < 1200MHz	2			dB	
LOSS (NOICES 4, 5)		1.2GHz ≤ f < 2.4GHz	2			1	
		2.4GHz ≤ f ≤ 3.0GHz	1				
Differential Input Signal Range	V _{RX-DIFF-PP}	SATA 2i, SATA 3i, MODE = GND (Note 4)	240		1000	mV _{P-P}	
		SATA 2i, SATA 3i, MODE = V _{CC} (Note 6)	220		1000		
Differential Output Swing VTX-DIFF-PI		f = 750MHz, f = 3.0GHz, PA = PB = GND (Notes 4, 6)	400		700	mV _{P-P}	
Output Preemphasis	V _{TX-DIFF-PP-PE}	f = 750MHz, PA = PB = V _{CC}		3		dB	
Input Equalization		V _{RX-DFF-PP} = 300mV _{P-P}		2.7		dB	
Preemphasis Time Period	t _{PE}	f = 750MHz, PA = PB = V _{CC}		150		ps	
Propagation Delay	t _{PD}			240		ps	
Output Rise/Fall Time	t _{TX-RISE-FALL}	PA = PB = GND, C _L = 0.5pF (Notes 5, 7)	40			ps	
		Data rate = 3.0Gbps, PA = PB = GND			17		
Deterministic Jitter (Notes 5, 8)	t _{TX-DJ-DD}	Data rate = 6.0Gbps, PA = PB = GND			20	ps _{P-P}	
Random Jitter	t _{TX-RJ-DD}	PA = PB = GND (Notes 5, 8)			1.5	ps _{RMS}	
OOB Detector Threshold		SATA OOB pattern, MODE = GND (Note 4)	75		200	m) (
OOD Detector Threshold	V _{OOB} _TH	SATA OOB pattern, MODE = V _{CC} (Note 6)	50		150	mV _{P-P}	
OOB Output Enter/Exit Time	tоов	(Notes 5, 9)		3	5	ns	
OOB Differential Offset Delta	ΔV _{OOB-DIFF}	(Note 10)	-100		+100	mV	

Ruggedized 6Gbps SATA Redriver with High ESD and Extended Temperature Operation

Electrical Characteristics (continued)

 $(V_{CC} = +3.0V \text{ to } +3.6V, C_{CL} = 10nF \text{ coupling capacitor on each output, } R_L = 50\Omega, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at } V_{CC} = +3.3V, T_A = +25^{\circ}C.)$ (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
OOB Common-Mode Delta	ΔV_{OOB-CM}	(Note 10)	-50		+50	mV
OOB Output Disable	V _{OOB-OUT}	V _{IN} < V _{CCB} (min), output voltage in squelch (Note 5)			30	mV _{P-P}
Dynamic Power-Down Exit Time	t _{DPD}	SATA OOB pattern (Note 5)			20	ns
Output Common-Mode Delta	ΔV _{OUT-CM}	(Note 11)	-25		+25	mV
LOGIC INPUT						
Input Logic-High	VIH	EN, CAD, PA, PB, MODE	1.4			V
Input Logic-Low	V _{IL}	EN, CAD, PA, PB, MODE			0.6	V
Input Logic Hysteresis	V _{HYST}	EN, CAD, PA, PB, MODE		0.1		V
Input Pullup/Pulldown Resistance				370		kΩ
ESD PROTECTION	ESD PROTECTION					
All Pins		Human Body Model		±8		kV

Note 3: All devices are 100% production tested at $T_A = +85^{\circ}C$. Specifications over the operating temperature range are guaranteed by design.

Note 4: This specification meets SATA version 3.0 (gold standard).

Note 5: Guaranteed by design.

Note 6: This specification meets SATA version 2.6 (gold standard).

Note 7: Rise and fall times are measured using 20% and 80% levels.

Note 8: DJ measured using K28.5 pattern; RJ measured using D10.2 pattern.

Note 9: Total time for OOB detection circuit to enable/squelch the output.

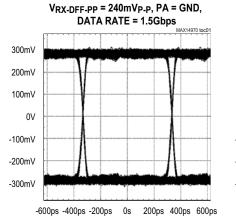
Note 10: Difference between squelched and not squelched in the active mode.

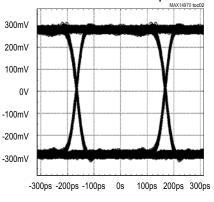
Note 11: Difference between output common mode in the active and dynamic power-down state.

Ruggedized 6Gbps SATA Redriver with High ESD and Extended Temperature Operation

Typical Operating Characteristics

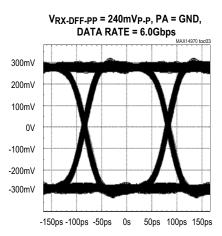
(V_{CC} = +3.3V, T_A = +25°C, all eye diagrams measured using K28.5 pattern, unless otherwise noted.)

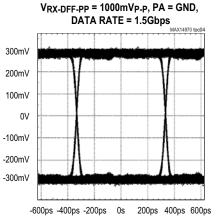


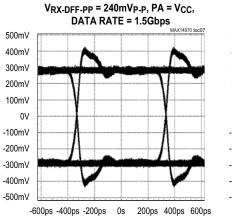


VRX-DFF-PP = 240mVP-P, PA = GND,

DATA RATE = 3.0Gbps

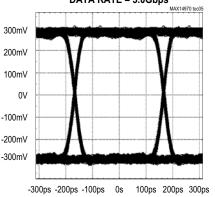




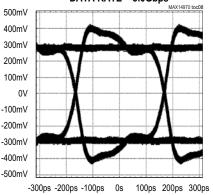


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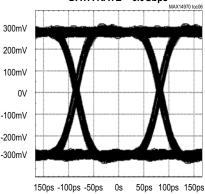
V_{RX-DFF-PP} = 1000mV_{P-P}, PA = GND, DATA RATE = 3.0Gbps



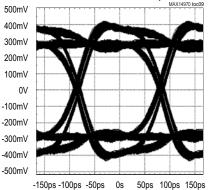
VRX-DFF-PP = 240mVP-P, PA = VCC, DATA RATE = 3.0Gbps



V_{RX-DFF-PP} = 1000mV_{P-P}, PA = GND, DATA RATE = 6.0Gbps



VRX-DFF-PP = 240mVP-P, PA = VCC, DATA RATE = 6.0Gbps

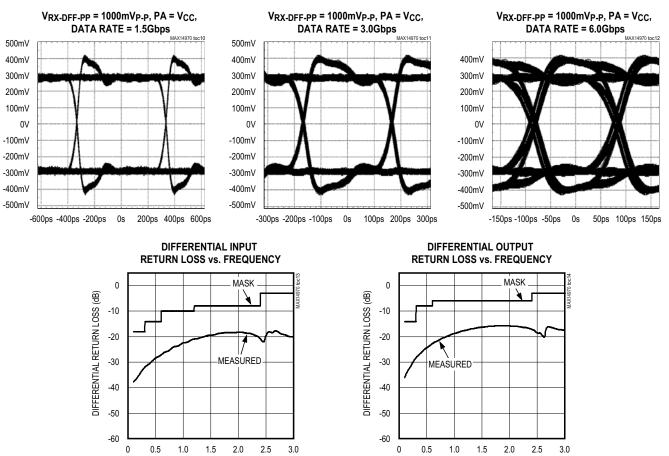


Ruggedized 6Gbps SATA Redriver with High ESD and Extended Temperature Operation

Typical Operating Characteristics (continued)

FREQUENCY (GHz)

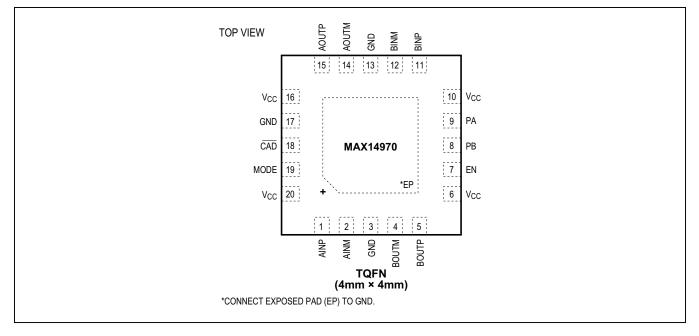
(V_{CC} = +3.3V, T_A = +25°C, all eye diagrams measured using K28.5 pattern, unless otherwise noted.)



0 0.5 1.0 1.5 2.0 FREQUENCY (GHz)

Ruggedized 6Gbps SATA Redriver with High ESD and Extended Temperature Operation

Pin Configuration



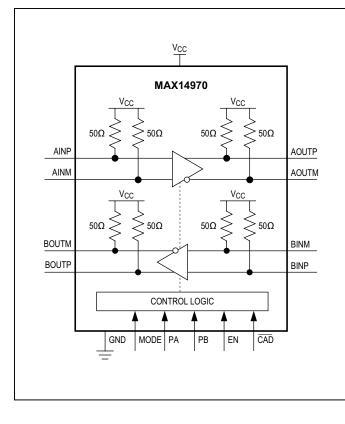
Pin Description

PIN	NAME	FUNCTION
1	AINP	Noninverting Input, Channel A
2	AINM	Inverting Input, Channel A
3, 13, 17	GND	Ground
4	BOUTM	Inverting Output, Channel B
5	BOUTP	Noninverting Output, Channel B
6, 10, 16, 20	V _{CC}	Positive Supply Voltage Input. Bypass V_{CC} to GND with 1µF and 0.01µF capacitors in parallel as close as possible to the device.
7	EN	Active-High Enable Input. Drive EN low to put the device in standby mode. Drive EN high for normal operation. EN has a $390k\Omega$ (typ) pulldown resistor.
8 PB		Channel B Preemphasis-Enable Input. Drive PB high to enable channel B output preemphasis. Drive PB low for standard SATA output level. PB has a 390kΩ (typ) pulldown resistor.

PIN	NAME	FUNCTION
9	PA	Channel A Preemphasis-Enable Input. Drive PA high to enable channel A output preemphasis. Drive PA low for standard SATA output level. PA has a $390k\Omega$ (typ) pulldown resistor.
11	BINP	Noninverting Input, Channel B
12	BINM	Inverting Input, Channel B
14	AOUTM	Inverting Output, Channel A
15	AOUTP	Noninverting Output, Channel A
18	CAD	Active-Low Cable-Detect Input. For external SATA applications, drive \overrightarrow{CAD} high to put the device in standby mode. Drive \overrightarrow{CAD} low for normal operation. \overrightarrow{CAD} has a 390k Ω (typ) pullup resistor. For internal SATA applications, connect \overrightarrow{CAD} to ground.
19	MODE	OOB Threshold Level Set. MODE has a $390k\Omega$ (typ) pulldown resistor.
	EP	Exposed Pad. Internally connected to GND. EP must be electrically connected to a ground plane for proper thermal and electrical operation.

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Functional Diagram/Truth Table



MODE V _{OOB_TH_LOW} (mV _{P-P})		V _{OOB_TH_HIGH} (mV _{P-P})
0	75	200
1	50	150

EN	PA	РВ	CHANNEL A	CHANNEL B
0	Х	х	STANDBY	STANDBY
1	0	0	STANDARD SATA	STANDARD SATA
1	1	0	PREEMPHASIS	STANDARD SATA
1	0	1	STANDARD SATA	PREEMPHASIS
1	1	1	PREEMPHASIS	PREEMPHASIS

EN	CAD	STATUS		
0	0	LOW-POWER STANDBY		
0	0 1 LOW-POWER STANDE			
1	0	ACTIVE		
1	1	LOW-POWER STANDBY		

NOTE: PA, PB, EN, AND MODE HAVE A 390k Ω RESISTOR PULLDOWN TO GND. CAD HAS A 390k Ω RESISTOR PULLUP TO V_{CC}. X = DON'T CARE.

Detailed Description

The MAX14970 consists of two identical buffers that take SATA input signals and return them to full SATA compliant output levels. Each buffer includes an equalizer, a limiting amplifier, and an output driver with preemphasis. The buffer outputs are protected from high-voltage electrostatic discharge (ESD) to ± 8 kV Human Body Model (HBM).

Input/Output Terminations

Inputs and outputs are internally 50Ω terminated and must be AC-coupled to the SATA controller IC and SATA device for proper operation.

OOB Signal Detection

The device provides full OOB signal support through highspeed, OOB-detection circuitry. SATA OOB differential input signals of $V_{OOB_TH_LOW}$ or less are detected as off and are not passed to the output. This prevents the system from responding to unwanted noise. SATA OOB differential input signals of V_{OOB_TH_HIGH} or more are detected as on and passed to the output. This allows OOB signals to transmit through the device. The time for the OOB detection circuit to detect an inactive SATA OOB input and squelch the associated output, or detect an active SATA OOB input and enable the output, is 3ns (typ). The MODE pin can be used to program the OOB detection range. When MODE = GND, the SATA version 3.0 range is used. When MODE = V_{CC}, the SATA version 2.6 range is used.

Enable Input

The device features an active-high enable input (EN). EN has an internal pulldown resistor of $390k\Omega$ (typ). Drive EN low or leave unconnected to place the device into low-power standby mode. In standby, the buffers are disabled, reducing the supply current to $20\mu A$ (typ). Drive EN high for normal operation.

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Cable-Detect Input

The device features an active-low, cable-detect input (\overline{CAD}) for use in external SATA applications. \overline{CAD} has an internal 390k Ω (typ) pullup resistor. Drive \overline{CAD} high or leave unconnected to place the device into low-power standby mode. In this mode, the buffers are disabled, reducing supply current to 20µA (typ). This signal is normally driven low by attaching a SATA cable into a properly wired socket (see Figure 4). If the cable-detect feature is not desired, connect \overline{CAD} to GND.

Dynamic Power-Down Mode

The device features a dynamic power-down mode where the device shuts down the major power-consuming circuitry. The device detects if the input signal is not present for a 4μ s (typ) duration. Normal operation resumes after 20ns (max) when a signal above the OOB threshold level is detected at the input. This function is implemented separately for both channels. The output common mode remains virtually unchanged when entering or exiting dynamic power-down mode, making the device ideal for internal SATA applications.

Output Preemphasis Selection Inputs

The device has two preemphasis control-logic inputs, PA and PB. PA and PB have internal $390k\Omega$ (typ) pulldown resistors. PA and PB enable preemphasis to the outputs of their corresponding buffers (see the *Functional Diagram/Truth Table*). Drive PA or PB low or leave unconnected for standard SATA output levels. Drive PA or PB high to provide preemphasis to the output. The preemphasis output signal compensates for attenuation from longer trace lengths or to meet internal SATA specifications.

Applications Information

Figure 1 shows a typical application circuit with the MAX14970 used to drive an internal SATA SDD or HDD. Figure 4 shows a typical application circuit with the MAX14970 used to drive an external SATA SSD or HDD.

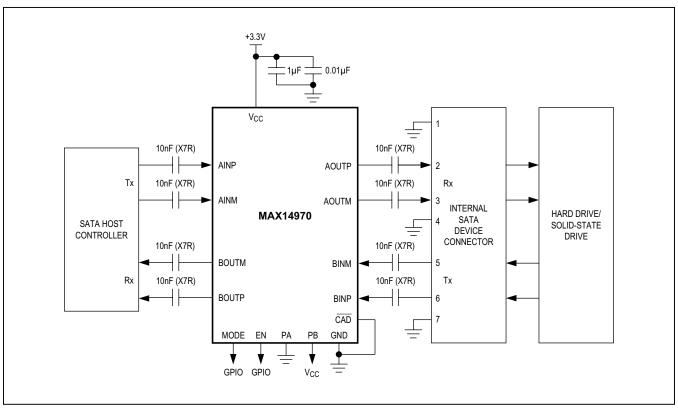


Figure 1. Typical Application Circuit for Internal SATA Applications

Ruggedized 6Gbps SATA Redriver with High ESD and Extended Temperature Operation

Exposed-Pad Package

The exposed-pad, 20-pin TQFN package incorporates features that provide a very low-thermal resistance path for heat removal from the device. The exposed pad on the device must be soldered to GND for proper thermal and electrical performance. For more information on exposed-pad packages, refer to <u>Application Note 862</u>: *HFAN-08.1*: *Thermal Considerations of QFN and Other Exposed-Paddle Packages*.

Layout

Use controlled-impedance transmission lines to interface with the device's high-speed inputs and outputs. Place power-supply decoupling capacitors as close as possible to the V_{CC} pin.

Power-Supply Sequencing

Caution: Do not exceed the absolute maximum ratings because stresses beyond the listed ratings can cause permanent damage to the device. Proper power-supply sequencing is recommended for all devices. Always apply V_{CC} before applying signals, especially if the signal is not current limited.

ESD Protection

As with all Maxim Integrated devices, ESD protection structures are incorporated on all pins to protect against electrostatic discharges encountered during handling and assembly. The MAX14970 is protected against ESD events up to ± 8 kV (HBM). The ESD structures withstand ± 8 kV in all states: normal operation and powered down. After an ESD event, the device continues to function without latchup.

HBM

The device is rated for ±8kV ESD protection using the HBM (MIL-STD-883, Method 3015). Figure 2 shows the HBM voltage, and Figure 3 shows the current waveform it generates when discharged into a low-impedance state. This model consists of a 100pF capacitor charged to the ESD voltage of interest that is then discharged into the device through a 1.5k Ω resistor.

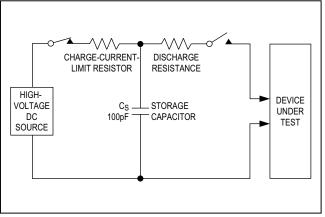


Figure 2. Human Body ESD Test Model

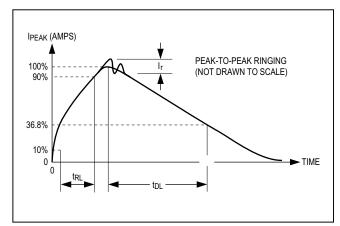


Figure 3. Human Body Current Waveform

Ruggedized 6Gbps SATA Redriver with High ESD and Extended Temperature Operation

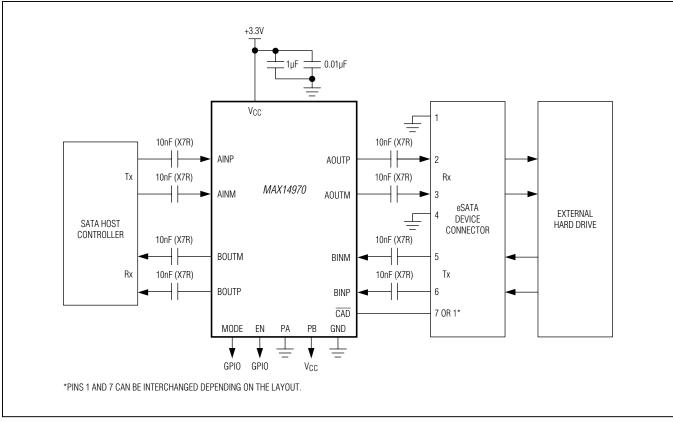


Figure 4. Typical Application Circuit for External SATA Application

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX14970ETP+	-40°C to +85°C	20 TQFN-EP*

+Denotes a lead(Pb)-free/RoHS-compliant package. *EP = Exposed pad.

Chip Information

PROCESS: BICMOS

Package Information

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	OUTLINE	LAND
TYPE	CODE	NO.	PATTERN NO.
20 TQFN-EP	T2044+2	<u>21-0139</u>	<u>90-0036</u>

Ruggedized 6Gbps SATA Redriver with High ESD and Extended Temperature Operation

Revision History

REVISION	REVISION	DESCRIPTION	PAGES
NUMBER	DATE		CHANGED
0	3/13	Initial release	—

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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